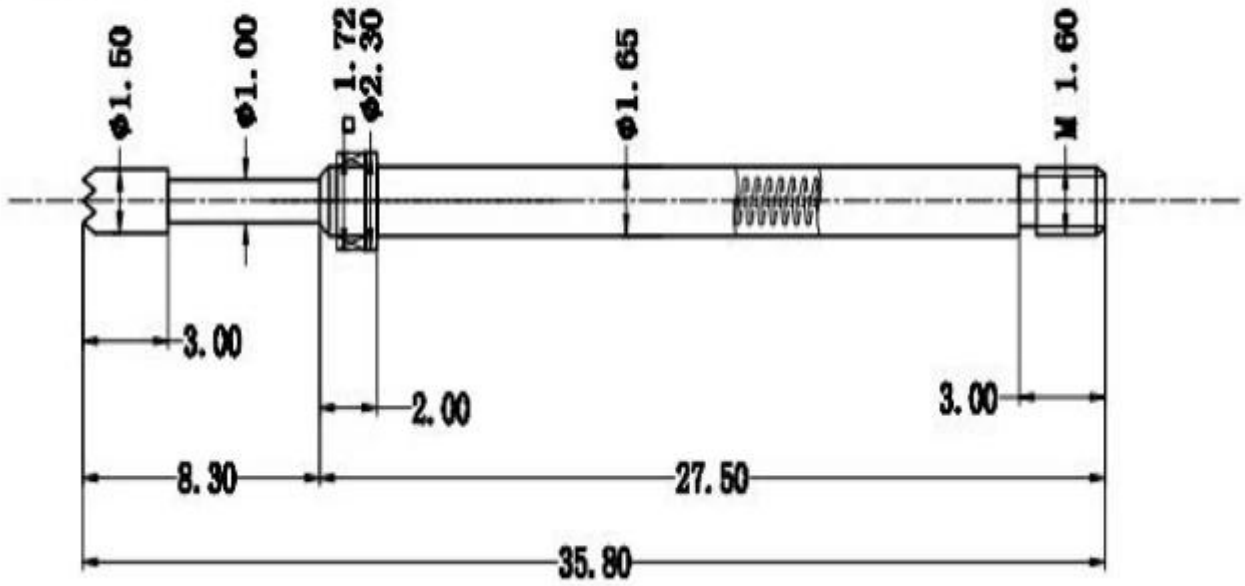
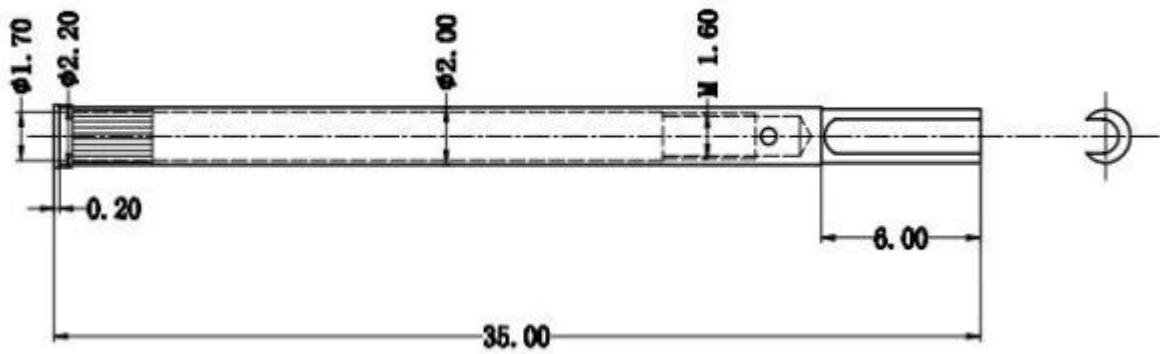
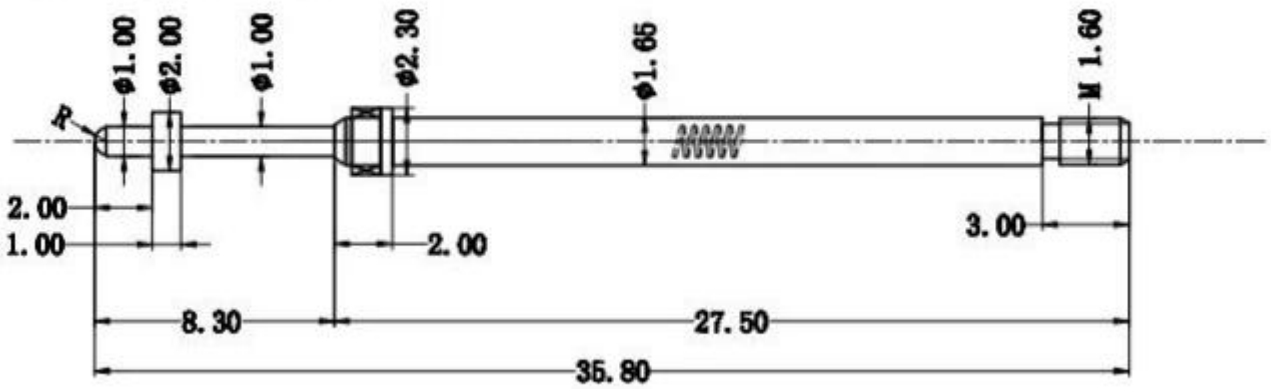


L112-H1.5



L112-JT1.0*2.0



1. □□□□□□□□24□□□□□□□□□□□□□□□□

2. 廠內生產之產品均採用OEM 廠牌

3. 廠內生產之產品均採用原廠材料

4. 廠內生產之產品均採用原廠材料



1.PCB ICT FCT 檢驗設備均採用原廠材料;

2. 廠內生產之產品均採用原廠材料 2 廠內生產之產品均採用原廠材料 ()

3. BGA 檢驗設備均採用原廠材料

4. 廠內生產之產品均採用原廠材料 QZ VZ LM;

5. 廠內生產之產品均採用原廠材料;

6. 廠內生產之產品均採用原廠材料;

7. 廠內生產之產品均採用原廠材料 30# OK POM

廠內生產之產品均採用原廠材料



1. Raw material warehouse



2. Lathe workshop



3. Assemble workshop



4. Quality inspection

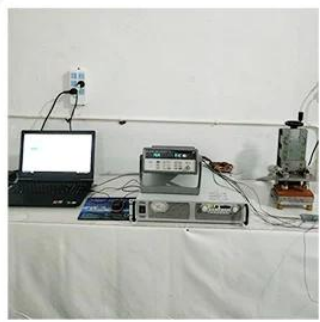


5. Finished products

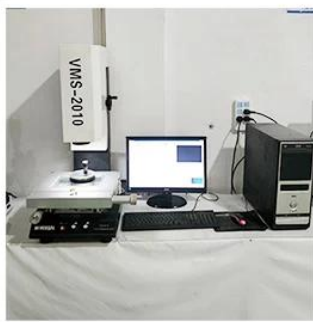


6. Packing





1. Agilent current testing



2. Quadratic element



3. Load Curve Meter



4. Bond Test



5. Life Fatigue Test



6. Microscope



2023 ISO Certificate



Patent for Coaxial Structure



Patent for Honeycomb current probe



Exwork|FOB|CNF|CIF

Exwork|FOB|CNF|CIF



Q1.

A1:

Q2.

A2:

Q3.

A3:

Q4.

A4:

Q5.

